

**Contact Dimensions:**

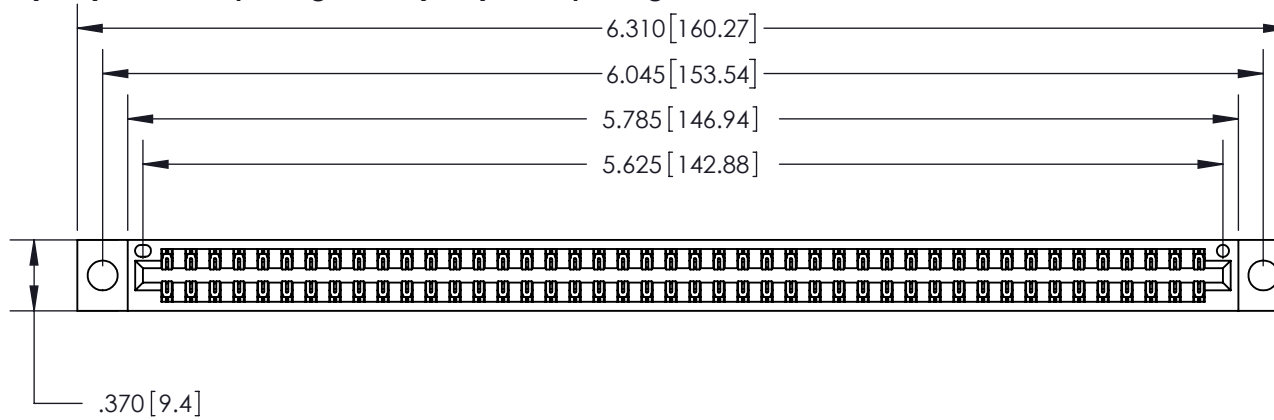
**526-P.C. Tail .018 Sq. (0.46 Sq.) - Tail LG. = .350 (8.89)**  
**.125 (3.18) Contact Spacing x .250 (6.35) Row Spacing**

THIS IS A C.A.D. GENERATED DRAWING  
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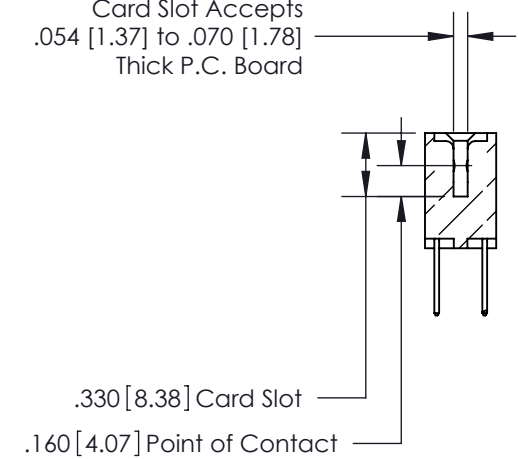
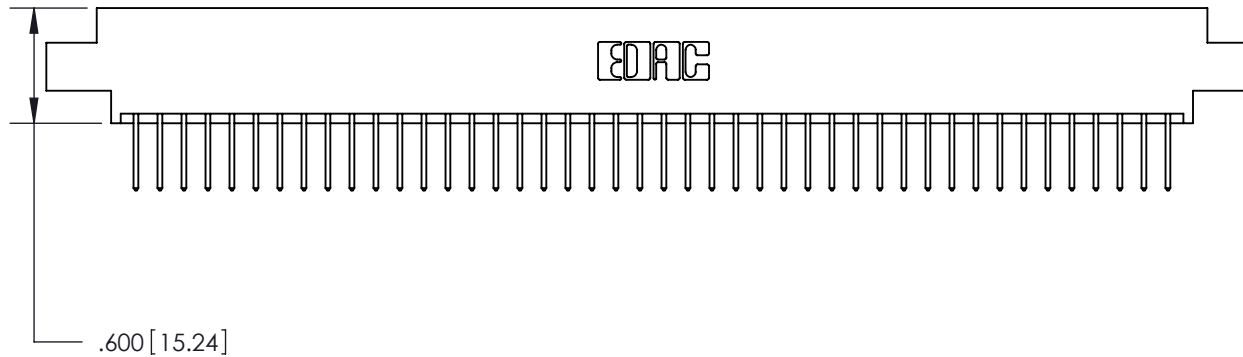


ISSUE NUMBER

ORIGINAL ①



Card Slot Accepts  
 .054 [1.37] to .070 [1.78]  
 Thick P.C. Board



- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0
- CONTACT MATERIAL: COPPER, NICKEL, TIN ALLOY CA-725
- CONTACT PLATING: GOLD ON THE MATING AREA, TIN-LEAD ON THE CONTACT TAILS, NICKEL UNDERPLATE

**846/896 SERIES HIGH TEMP CARD EDGE CONNECTOR**  
**PART NUMBER: 896-088-526-804**



YOUR CONNECTION TO QUALITY & SERVICE

EDAC INC  
 TORONTO, ONTARIO  
 CANADA

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ACAD REFERENCE NO. 846-ENG-MASTER

DRAWN: J.LEE DATE: APR. 22/09

CHECKED: DATE:

SCALE: 1:1 SHEET 1 OF 2

DRAWING NUMBER 846-ENG-MASTER ISSUE 1

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ISSUE NUMBER	
ORIGINAL	①



**Contact Code 555**



**Contact Code 556**



**Contact Code 558**



**Contact Code 559**



**Contact Code 560**

- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0
- CONTACT MATERIAL: COPPER, NICKEL, TIN ALLOY CA-725
- CONTACT PLATING: GOLD ON THE MATING AREA, TIN-LEAD ON THE CONTACT TAILS, NICKEL UNDERPLATE

<b>846/896 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS</b>		ACAD REFERENCE NO. 846-ENG-MASTER
		DRAWN: J.LEE      DATE: APR. 22/09
		CHECKED:      DATE:
		SCALE: 1:1      SHEET 2 OF 2
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